507014705 12/07/2021

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
ZIANG LI	12/03/2021
YAN SHAO	12/03/2021
ZHIYONG CUI	12/03/2021

RECEIVING PARTY DATA

Name:	AAC MICROTECH (CHANGZHOU) CO., LTD.
Street Address:	NO.3 CHANGCAO ROAD, HI-TECH INDUSTRIAL ZONE, WUJIN DISTRICT, CHANGZHOU CITY, JIANGSU PROVINCE, P.R. CHINA
City:	CHANGZHOU
State/Country:	CHINA

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17541286

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	2021A0061US1
NAME OF SUBMITTER:	MICHAEL P. WIERSCH
SIGNATURE:	/Michael P. Wiersch #55996/
DATE SIGNED:	12/07/2021

Total Attachments: 4

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PATENT 507014705 REEL: 058329 FRAME: 0501

ASSIGNMENT

2.200.200.0000
WHEREAS I/We, the below named inventor(s) (hereinafter referred to as Assignor(s)) have made an invention entitled:
LINEAR VIBRATION MOTOR
for which I/We executed an application for United States Letters Patent concurrently herewith or filed an application for United States Letters Patent on(Application No); and
WHEREAS, AAC Microtech (Changzhou) Co., Ltd. a corporation of China whose post office address is No.3 changcac road, Hi-TECH Industrial Zone, Wujin District, Changzhou City, Jiangsu Province, P.R. China (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;
NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I/We, as Assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention, provisional Application No
AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;
AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful caths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.
AND, I/WE HEREBY authorize and request the attorneys I/we have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No, filed) the filing date and application number of said application when known.

	2								

Attorney Docket No.: 2021A0061US1

US Rights Page 2

Inventor:

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Signature:

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Date:

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Attorney Docket No.: 2021A0061US1

US Rights Page 3

Inventor:

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2021. 12.03

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US Rights Page 4

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RECORDED: 12/07/2021